

Glass Passivated Single Phase Bridge Rectifiers

Reverse Voltage 200 to 1000V
Forward Current 6.0 Amp

Features

- Glass passivated die construction
- Ideal for printed circuit boards
- Plastic material used carries UL flammability recognition 94V-0
- High surge current capability
- High temperature soldering guaranteed: 265°C /10 seconds, 0.375" (9.5mm) lead length, 5lbs. (2.3kg) tension

Mechanical Data

Case: Molded plastic case

Terminals: Plated leads solderable per MIL-STD-750, Method 2026

Polarity: Marked on Body

Mounting Position: Any

Module Type

TYPE	V _{RRM}	V _{RSM}
GBU6D	200V	300V
GBU6G	400V	500V
GBU6J	600V	700V
GBU6K	800V	900V
GBU6M	1000V	1100V

Maximum Ratings and Thermal Characteristics (TA = 25°C unless otherwise noted)

Symbol	Conditions	Values	Units
I _{F(AV)}	Maximum average forward output rectified current T _c = 100°C	6.0 ⁽¹⁾	A
I _{FSM}	Peak forward surge current single half sine-wave superimposed on rated load (JEDEC Method)	175	A
i ² t	Rating for fusing (t < 8.3ms)	127	A ² s
V _{ISOL}	a.c. 50HZ; r.m.s.; 1min	2500	V
R _{θJA} R _{θJC}	Maximum thermal resistance per leg	22 ⁽²⁾ 4.2 ⁽³⁾	°C/W
T _j , T _{STG}	Operating Junction and storage temperature range	-55 to +150	°C
Weight	Approximate Weight	4.0	g

Electrical Characteristics (TA = 25°C unless otherwise noted)

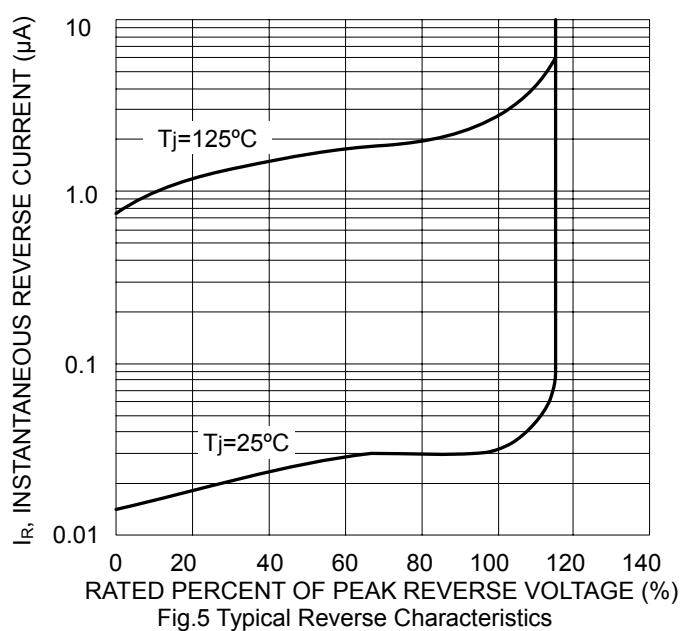
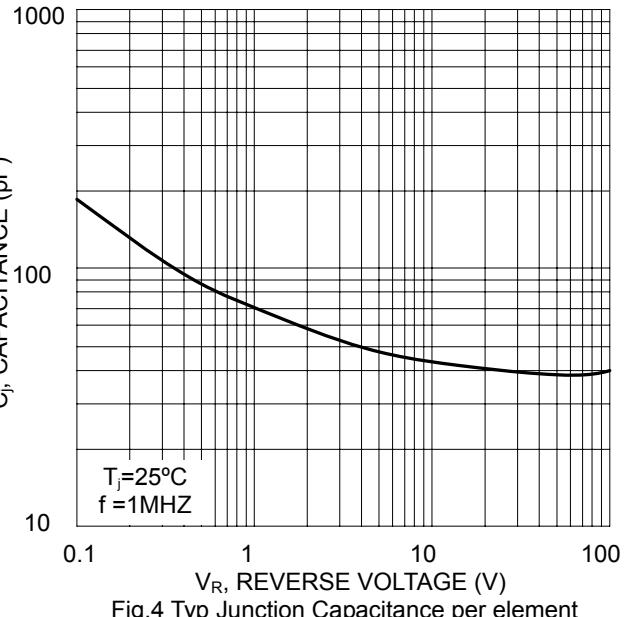
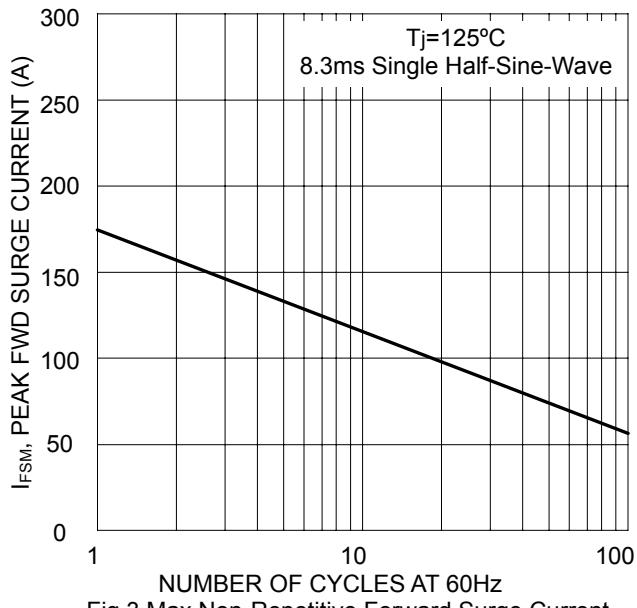
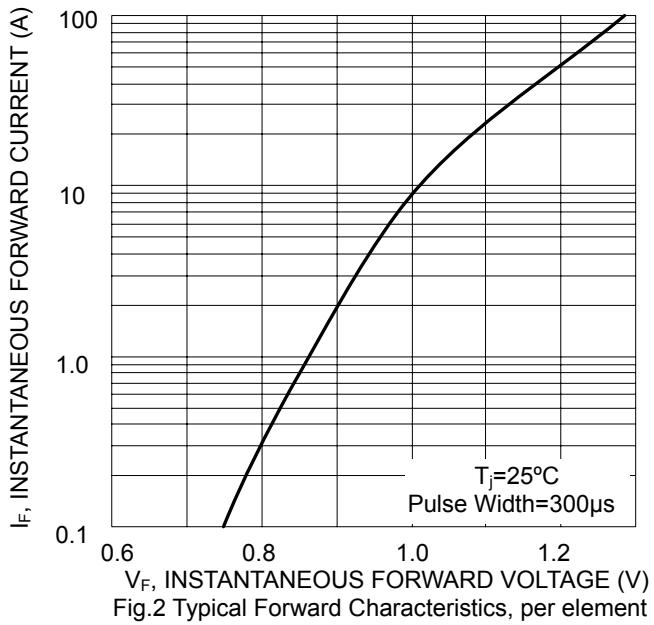
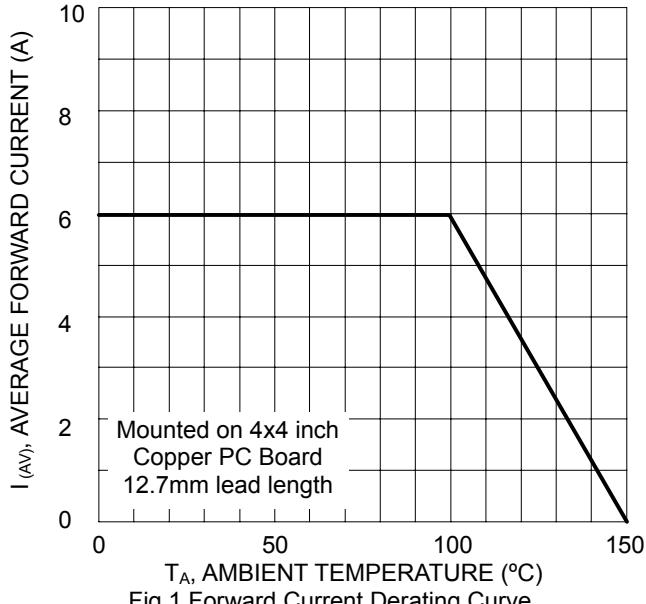
Symbol	Conditions	Values	Units
V _F	Maximum Instantaneous Forward Voltage per leg I _{FM} = 6.0A	1.1	V
I _R	Maximum DC reverse current at rated TA = 25°C DC blocking voltage per leg TA = 125°C	5.0 500	μA

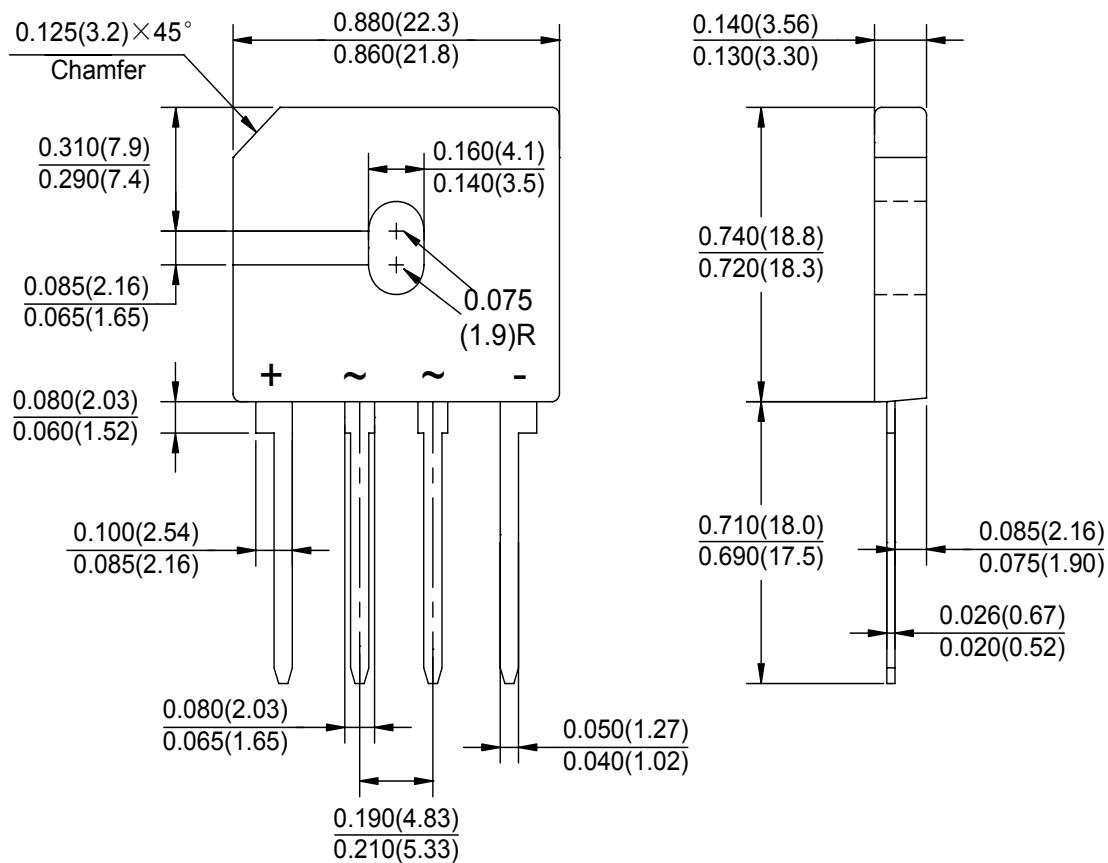
Notes: (1) Heat sink, T_c mounting-4x4x0.15cm thick copper plate

(2) Junction to ambient without heatsink

(3) Junction to case with heatsink

(4) Recommended mounting position is to bolt down on heatsink with silicone thermal compound for maximum heat transfer with M3 screw

Performance Curves


Package Outline Information
CASE: GBU

Dimensions in inches (mm)